
Mixed Signal Mobile Embedded Flash ARC EC BC-Link/ VLPC Base Component

Product Features

- 3.3V Operation
- ACPI Compliant
- LPC Interface
 - LPC I/O and Trusted Cycles Decoded
- VTR (standby) and VBAT (Power Planes)
 - Low Standby Current in Sleep Mode
- Configuration Register Set
 - Compatible with ISA Plug-and-Play Standard
 - EC-Programmable Base Address
- ARC-625D Embedded Controller (EC)
 - 16 KB Single Cycle 32-bit Wide Dual-ported SRAM, Accessible as Closely Coupled Data Memory and Instruction Memory
 - 2 KB Instruction Cache and AHB Memory-mapped SPI Flash Read Controller
 - 32 x 32 x 64 Fast Multiply
 - Divide Assist and Saturation Arithmetic
 - Maskable Interrupt Aggregator/Accelerator Interface
 - Maskable Hardware Wake-Up Events
 - Sleep mode
 - JTAG Debug Port, Includes JTAG Master
 - MCU Serial Debug Port
 - 8-Channel DMA Interface Supports SMBus Controllers and EC/Host GP-SPI Controllers
- Embedded Flash
 - 192 KB user space + 2kB info block, 32-bit Access, 35ns Access Time, 1 K Cycles Endurance
 - Programmable by LPC, EC and JTAG Interfaces
 - Flash Security Enhancements
 - 4K Boot Block Protection
 - Direct JTAG and Direct LPC-protected (2) Pages at or Near Top of Memory for Password Protection
- Legacy Support
 - Fast GATEA20 & Fast CPU_RESET
- System to EC Message Interface
 - 8042 Style Host Interface
- Embedded Memory Interface
 - Host Serial or Parallel IRQ Source
 - Provides Two Windows to On-Chip SRAM for Host Access
 - Two Register Mailbox Command Interface
 - Host Access of Virtual Registers Without EC Intervention
- Mailbox Registers Interface
 - Thirty-two 8-Bit Scratch Registers
 - Two Register Mailbox Command Interface
 - Two Register SMI Source Interface
- ACPI Embedded Controller Interface
 - Four Instances
 - 1 or 4 Byte Data transfer capable
- ACPI Power Management Interface
 - SCI Event-Generating Functions
- Battery Backed Resources
 - Power-Fail Status Register
 - 32 KHz Clock Generator
 - Week Alarm Timer Interface with Programmable Wake-up from 1ms to 45 Days
 - VBAT-Powered Control Interface
 - VBAT-Backed 64 Byte Memory
- Three EC-based SMBus 2.0 Host Controllers
 - Allows Master or Dual Slave Operation
 - Controllers are Fully Operational on Standby Power
 - DMA-driven I²C Network Layer Hardware
 - I²C Datalink Compatibility Mode
 - Multi-Master Capable
 - Supports Clock Stretching
 - Programmable Bus Speeds
 - 400 KHz Capable
 - Hardware Bus Access "Fairness" Interface
 - SMBus Time-outs Interface
 - 8 x 3 x 3 Port Multiplexing
- PECI Interface 2.0
- 18 x 8 Interrupt Capable Multiplexed Keyboard Scan Matrix
- Three independent Hardware Driven PS/2 Ports
 - Fully functional on Main and/or Suspend Power
 - PS/2 Edge Wake Capable
- 115 General Purpose I/O Pins
 - 8 GPIO Pass-Through Port (GPTP)

MEC1609/MEC1609i

- 3-pin LED Interface
 - Programmable Blink Rates
 - Breathing LED Output
 - Operational in EC Sleep State
- Programmable 16-bit Counter/Timer Interface
 - Four Wake-capable 16-bit Auto-reloading Counter/Timer Instances
 - Four Operating Modes per Instance: Timer, One-shot, Event and Measurement.
 - 4 External Inputs, 4 External Outputs
- Hibernation Timer Interface
 - Two 32.768 KHz Driven Timers
 - Programmable Wake-up from 0.5ms to 128 Minutes
- System Watch Dog Timer (WDT)
- Input Capture and Compare Timer
 - 32-bit Free-running timer
 - Six 32-bit Capture Registers
 - Two 32-bit Compare Registers
 - Capture, Compare and Overflow Interrupts
- Microchip's Multipoint VLPC™ Serial Interconnect Bus Master
 - Forwards LPC transactions to VLPC peripherals
 - Forwards ARC transactions to VLPC peripherals
- BC-Link™ Interconnection Bus
 - Three High Speed and one Low Speed Bus Masters Controllers
- Two General Purpose Serial Peripheral Interface Controllers (ECGP-SPI)
 - One 3-pin EC-driven Full Duplex Serial Communication Interface
 - One 4-pin EC/Host-driven Full Duplex Serial Communication Interface to SPI Flash Interface
 - Flexible Clock Rates
 - SPI Burst Capable
- SPI Flash Read Controller
 - 4 MB AHB Memory-Mapped address space
 - Supports 2 KB EC Instruction Cache
- FAN Support
 - 8 Programmable Pulse-Width Modulator Outputs
 - Multiple Clock Rates
 - 16-Bit 'On' & 16-Bit 'Off' Counters
 - Four Fan Tachometer Inputs
 - 6 x 2 Capture/Compare Timer Interface
- ADC Interface
 - 10-bit Conversion in 10μs
 - 16 Channels
 - Integral Non-Linearity of ± 0.5 LSB; Differential Non-Linearity of ± 0.5 LSB
- Two Pin Debug Port with Standard 16C550A Register Interface
 - Accessible from Host and EC
 - Programmable Input/output Pin Polarity Inversion
 - Programmable Main Power or Standby Power Functionality
 - Standard Baud Rates to 115.2 Kbps, Custom Baud Rates to 2 Mbps
- Resistor/Capacitor Identification Detection (RC_ID)
 - Single Pin Interface to External Inexpensive RC Circuit
 - Replacement for Multiple GPIO's
 - Provides 8 Quantized States on One Pin
- Integrated Standby Power Reset Generator
- Clock Generator
 - 32.768 KHz-input Clock
 - operational on Suspend Power
 - Programmable Clock Power Management Control & Distribution
 - 64.52 MHz $\pm 2\%$ Accuracy
- Packages
 - 144 Pin LFBGA RoHS Compliant package
 - 144 Pin TFBGA RoHS Compliant package
- Operating Temperature
 - The MEC1609 supports the commercial temperature range of 0°C to +70°C
 - The MEC1609i supports the industrial temperature range of -40°C to +85°C

Description

The MEC1609/MEC1609i is the mixed signal base component of a multi-device advanced I/O controller architecture. The MEC1609/MEC1609i incorporates a high-performance 32-bit ARC 625 embedded microcontroller with a 192 Kilo-byte embedded Flash subsystem, 16 Kilobytes of SRAM and 2 Kilobytes of instruction cache with an AHB memory-mapped SPI Flash Read Controller. The MEC1609 communicates with the system host using the Intel® Low Pin Count bus.

There are two distinct protocols that provide communication between the MEC1609/MEC1609i base component and companion components: BC-Link™ and VLPC™. BC-Link™ in the MEC1609/MEC1609i can access up to four companion components. The BC-Link™ protocol is peer-to-peer providing communication between the MEC1609/MEC1609i embedded controller and registers located in a companion. VLPC™ is a multi-drop protocol that matches the MEC1609/MEC1609i with up to three untrusted companion components and one trusted companion component. The MEC1609/MEC1609i accepts LPC Host (ICH/PCH) transactions targeting blocks internal to the MEC1609/MEC1609i and blocks physically located in VLPC™ companions. The ARC 625 embedded microcontroller can also access blocks that are physically located in VLPC™ companion components.

The MEC1609/MEC1609i is directly powered by two separate suspend supply planes (VBAT and VTR) and senses a third runtime power plane (VCC) to provide “instant on” and system power management functions. The MEC1609/MEC1609i also contains an integrated VTR Reset Interface and a system Power Management Interface that supports low-power states and can drive state changes as a result of hardware wake events as defined by the MEC1609/MEC1609i Wake Interface.

The MEC1609/MEC1609i defines a software development system interface that includes an MCU Serial Debug Port, a two pin serial debug port with a 16C550A register interface that is accessible to the EC or to the LPC host and can operate up to 2 MB/s, a flexible Flash programming interface and a JTAG interface. The EC can also drive the JTAG interface as a master.

A top-level block diagram of the MEC1609/MEC1609i is shown in [FIGURE 1: MEC1609/MEC1609i Top-Level Block Diagram on page 5](#). An example of system level connection is shown in [FIGURE 2: Example of MEC1609/MEC1609i's Connections to System Components on page 6](#).

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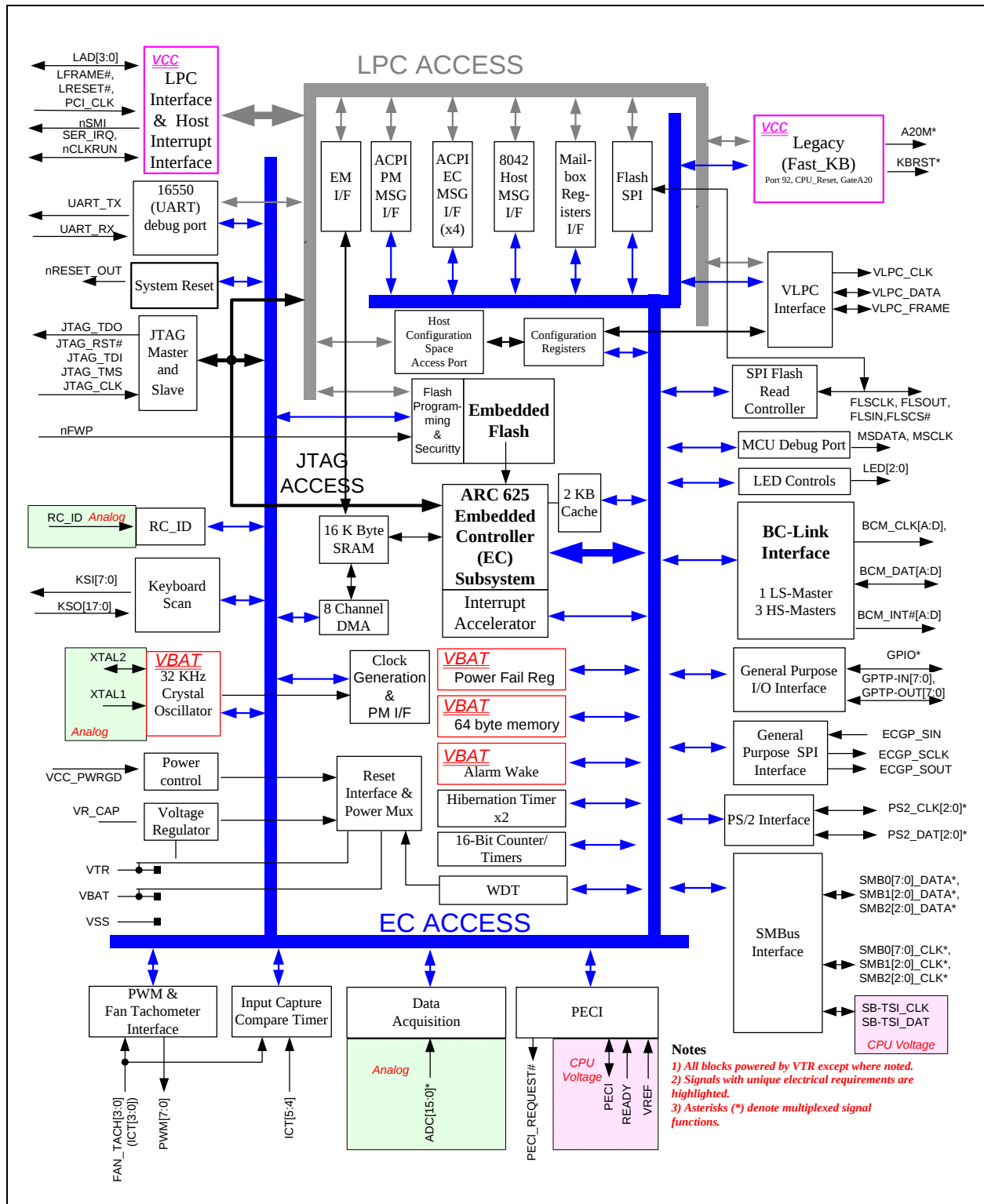
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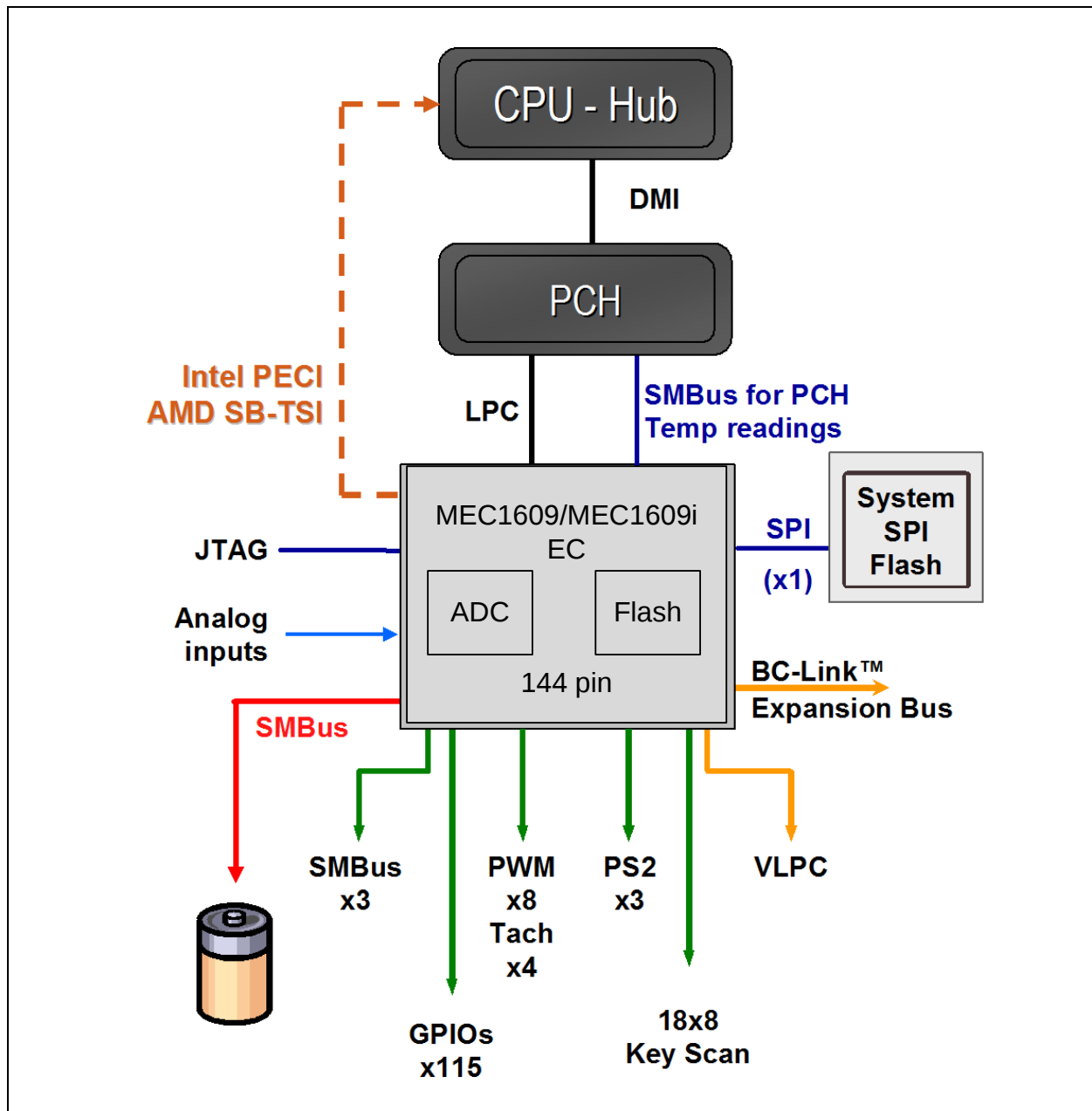
BLOCK DIAGRAM

FIGURE 1: MEC1609/MEC1609i TOP-LEVEL BLOCK DIAGRAM



MEC1609/MEC1609i

FIGURE 2: EXAMPLE OF MEC1609/MEC1609i'S CONNECTIONS TO SYSTEM COMPONENTS



PACKAGE OUTLINES

Note: For the most current package drawings, see the Microchip Packaging Specification at <http://www.microchip.com/packaging>.

FIGURE 3: 144-PIN LFBGA 10X10X0.8 MM PACKAGE OUTLINE (1.4 MM HEIGHT)

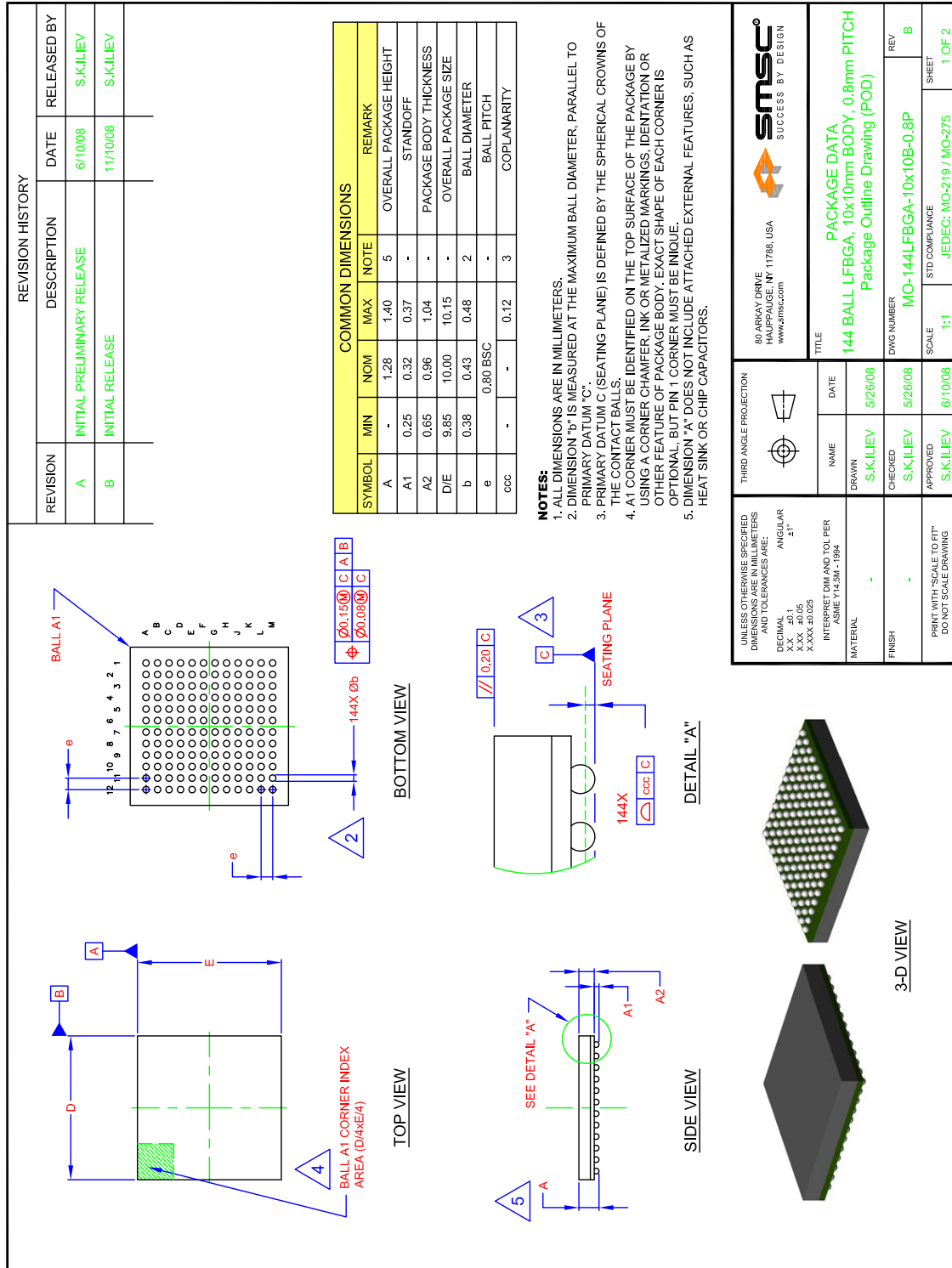
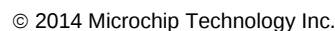


FIGURE 4: 144-PIN TFBGA 7X7X0.5 MM PACKAGE OUTLINE (1.2 MM HEIGHT)



APPENDIX A: PRODUCT BRIEF REVISION HISTORY

TABLE A-1: REVISION HISTORY

Revision	Section/Figure/Entry	Correction
DS00001769A (06-03-14)	Document Release	

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<u>PART NO.</u>		<u>[X]</u>	-	<u>XXX</u>	-	<u>[X]⁽¹⁾</u>
Device		Temperature Range		Package	Tape and Reel Option	
Device:		MEC1609, MEC1609i				
Temperature Range:		Blank	=	0°C to +70°C	(Extended Commercial)	
		i	=	-40°C to +85°C	(Industrial)	
Package:		PZV	=	144-pin TFBGA		
		PZP	=	144-pin LFBGA		
Tape and Reel Option:		Blank	=	Standard packaging (tray)		
		TR	=	Tape and Reel ⁽¹⁾		

Examples:

- a) MEC1609-PZV
144-pin TFBGA (7mm x 7mm, 0.5 pitch)
RoHS Compliant package
- b) MEC1609-PZP
144-pin TFBGA (10mm x 10mm, 0.8 pitch)
RoHS Compliant package
- c) MEC1609i-PZV
Industrial temperature,
144-pin TFBGA (7mm x 7mm, 0.5 pitch)
RoHS Compliant package
- d) MEC1609i-PZP
Industrial temperature,
144-pin TFBGA (10mm x 10mm, 0.8 pitch)
RoHS Compliant package

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ISBN: 9781632762627

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